

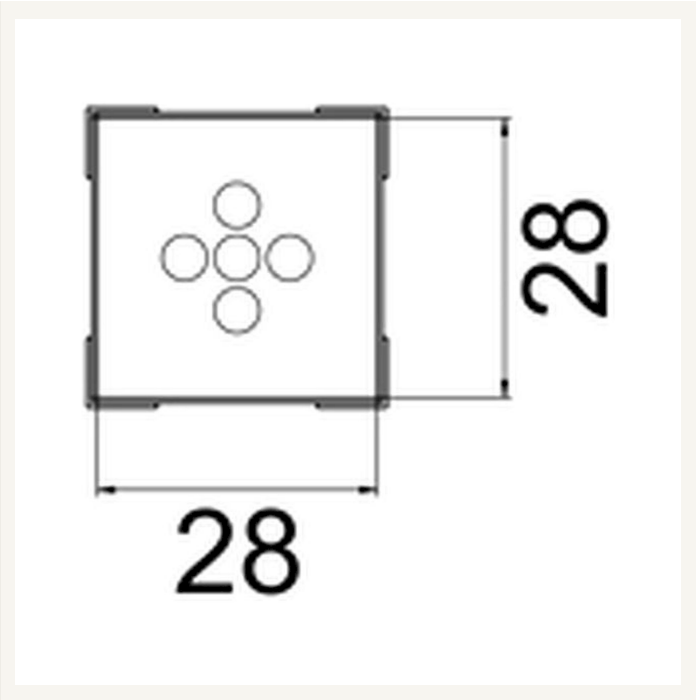
Hot Air Nozzle BGA 27×27mm - Hakko A1475

Item no. HK-A1475	Manufacturer Hakko	EAN 4962615517235
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Replacement hot air nozzle with 27×27mm BGA opening for Hakko 850, FR-801, FR-802, and FR-803 hot air rework stations. Enables precise thermal profiling for ball grid array component soldering and desoldering.

TECHNICAL DATA

Ausführungsklasse	TEC
Country of Manufacture	Japan
HS-Code	85159080
Note	Es gibt keine Lieferung von Hakko Produkten in die Schweiz
Weight	0.0099 kg



DESCRIPTION

OVERVIEW

The Hakko A1475 is a precision hot air nozzle designed for BGA (Ball Grid Array) rework applications. With a 27×27mm opening, it delivers focused thermal energy for controlled soldering and desoldering of fine-pitch BGA packages on PCBs. Compatible with Hakko 850, FR-801, FR-802, and FR-803 hot air stations.

KEY FEATURES

- 27×27mm BGA-optimized nozzle opening
- Uniform heat distribution for consistent reflow profiles
- Compatible with multiple Hakko hot air station models
- Durable ceramic construction
- Precision-engineered for professional rework

TECHNICAL SPECIFICATIONS

Nozzle Type	BGA Hot Air
Opening Size	27×27mm
Compatible Stations	Hakko 850, FR-801, FR-802, FR-803

Country of Origin	Japan
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APPLICATIONS

Ideal for BGA rework, fine-pitch component soldering, and thermal profiling in electronics manufacturing and repair. Suitable for prototype development, production rework, and field service applications.